#### TOSHIBA BIPOLAR DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

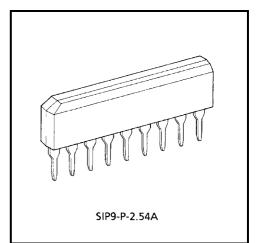
# TD62551S,TD62553S,TD62554S,TD62555S

### 4CH SINGLE DRIVER : COMMON EMITTER

The TD62551S are comprised of four NPN transistor arrays. Applications include relay, hammer, lamp and display (LED) drivers.

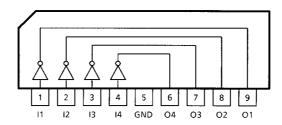
### FEATURES

- Output current (single output) 150 mA (Max)
- High sustaining voltage output 25 V (Min)
- Low saturation voltage VCE (sat) =  $0.5 \text{ V} @I_{OUT} = 50 \text{ mA}$
- Inputs compatible with various types of logic.
- TD62551S : External
- TD62553S  $: R_{IN} = 2.7 \text{ k}\Omega \dots \text{ TTL}, 5 \text{ V CMOS}$
- TD62554S :  $R_{IN} = 10.5 \text{ k}\Omega \dots 6 \sim 15 \text{ V PMOS}$ , CMOS
- TD62555S :  $R_{IN} = 20 \text{ k}\Omega \dots 12 \text{ }24 \text{ V PMOS}$
- Package type : SIP-9 pin

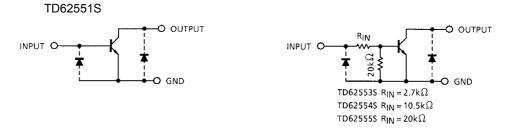


Weight: 0.92 g (Typ.)

# PIN CONNECTION



# SCHEMATICS (EACH DRIVER)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

# MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	V <sub>CEO</sub>	25	V
Collector-Base Voltage	V <sub>CBO</sub>	35	V
Collector Current	Ι <sub>C</sub>	150	mA / ch
Input Voltage	V <sub>IN</sub> (Note 1)	20	V
Input Current	I <sub>IN</sub> (Note 2)	10	mA
Power Dissipation	P <sub>D</sub> (Note 3)	0.75	W
Operating Temperature	T <sub>opr</sub>	-40~85	°C
Storage Temperature	T <sub>stg</sub>	-55~150	°C

Note 1: Except TD62551S

Note 2: Only TD62551S

Note 3: Delated above 25°C in the proportion of 6.0mW / °C.

# **RECOMMENDED OPERATING CONDITIONS (Ta = -40~85°C)**

CHARAC	TERISTIC	SYMBOL	CONDITION	MIN	TYP.	MAX	UNIT
Collecter-Emitter	ollecter-Emitter Voltage V <sub>CEO</sub>		_	0	_	25	V
Collecter-Base Voltage		V <sub>CBO</sub>	_	0	_	35	V
	TD62551S TD62553S	IC	_	0	_	100	mA / ch
	TD62554S			0	_	80	
	TD62555S			0	_	60	
Input Voltage	TD62553S TD62554S TD62555S	V <sub>IN</sub>	_	0	_	20	V
Input Current	TD62551S	I <sub>IN</sub>	_	0	_	5	mA
Power Dissipation		PD	—		_	0.27	W

# ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARAC	TERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN	TYP.	MAX	UNIT
Output Leakage Current		ICEX	1	V <sub>CE</sub> = 25 V, V <sub>IN</sub> = 0 V	-		10	μA
Collector-Emitter Saturation Voltage		V <sub>CE (sat)</sub>	2	I <sub>IN</sub> = 0.5 mA, I <sub>C</sub> = 10 mA	_	0.15	0.2	v
				I <sub>IN</sub> = 2.5 mA, I <sub>C</sub> = 50 mA	-	0.35	0.5	
DC Current	(Note 1)	h <sub>FE</sub>	2	2 V <sub>CE</sub> = 5 V, I <sub>C</sub> = 10 mA	60	-	400	_
Transfer Ratio	(Note 2)		2		50		400	
Input Voltage TD	TD62553S	V <sub>IN (ON)</sub>	3	3 I <sub>IN</sub> = 0.5 mA, I <sub>C</sub> = 10 mA	1.7	2.1	2.5	V
	TD62554S				4.4	6.0	7.6	
	Td62555S				7.7	10.7	13.8	
Turn-On Delay Turn-Off Delay		t <sub>ON</sub>	- 4	$V_{OUT}$ = 25 V, R <sub>L</sub> = 210 Ω C <sub>L</sub> = 15 pF	_	100	_	ns
		t <sub>OFF</sub>				500	_	

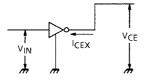
Note 1: Except TD62551S. Note 2: Only TD62551S.

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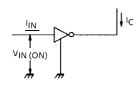
# <u>TOSHIBA</u>

# **TEST CIRCUIT**

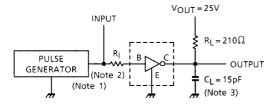
#### 1. ICEX

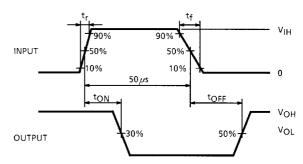


#### 3. VIN (ON)



#### 4. t<sub>ON</sub>, t<sub>OFF</sub>





Note 1: Pulse Width 50  $\mu$ s, Duty Cycle 10% Output Impedance 50  $\Omega$ , t<sub>f</sub> ≤ 5 ns, t<sub>f</sub> ≤ 10 ns

- Note 2: See right.
- Note 3: CL includes probe and jig capacitance.

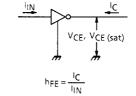
#### INPUT CONDITION

TYPE NUMBER	RI	VIH
TD62551S	2.7 kΩ	3 V
TD62553S	0 Ω	3 V
TD62554S	0 Ω	10 V
TD62555S	0 Ω	14 V

# **PRECAUTIONS for USING**

This IC does not integrate protection circuits such as overcurrent and overvoltage protectors. Thus, if excess current or voltage is applied to the IC, the IC may be damaged. Please design the IC so that excess current or voltage will not be applied to the IC.

Utmost care is necessary in the design of the output line, V<sub>CC</sub> and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.



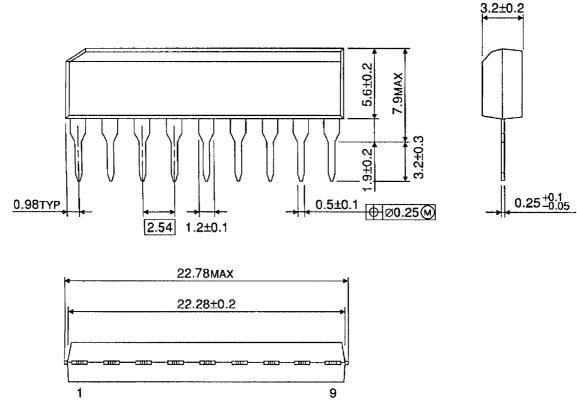
2. hFE, VCE (sat)

# TOSHIBA

#### PACKAGE DIMENSIONS

SIP9-P-300-2.54A

Unit: mm



Weight: 0.92 g (Typ.)

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